

General Description

The MAX5969D provides a complete interface for a powered device (PD) to comply with the IEEE® 802.3af/ at standard in a power-over-Ethernet (PoE) system. The MAX5969D provides the PD with a detection signature, classification signature, and an integrated isolation power switch with inrush current control. During the inrush period, the MAX5969D limits the current to less than 180mA before switching to the higher current limit (720mA to 880mA) when the isolation power MOSFET is fully enhanced. The device features an input UVLO with wide hysteresis and long deglitch time to compensate for twisted-pair cable resistive drop and to assure glitch-free transition during power-on/-off conditions. The MAX5969D can withstand up to 100V at the input.

The MAX5969D supports a 2-event classification method as specified in the IEEE 802.3at standard and provide a signal to indicate when probed by a Type 2 power sourcing equipment (PSE). The device detects the presence of a wall adapter power source connection and allow a smooth switch over from the PoE power source to the wall power adaptor.

The MAX5969D also provides a power-good (PG) signal, two-step current limit and foldback, overtemperature protection, and di/dt limit. The MAX5969D is available in a 16-pin, 5mm x 5mm TQFN power package. This device is rated over the -40°C to +85°C extended temperature range.

Features

- ♦ IEEE 802.3af/at Compliant
- ♦ 2-Event Classification or an External Wall Adapter **Indicator Output**
- **♦ Simplified Wall Adapter Interface**
- ♦ PoE Classification 0-5
- **♦ 100V Input Absolute Maximum Rating**
- ♦ Inrush Current Limit of 180mA Maximum
- ♦ Current Limit During Normal Operation Between 720mA and 880mA
- ♦ Current Limit and Foldback
- ♦ Legacy UVLO at 36V
- **♦** Overtemperature Protection
- ◆ Thermally Enhanced, 5mm x 5mm, 16-Pin TQFN

Applications

IEEE 802.3af/at Powered Devices

IP Phones, Wireless Access Nodes, IP Security Cameras

WiMAX™ Base Stations

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE		
MAX5969DETE+	-40°C to +85°C	16 TQFN-EP*		

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

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^{*}EP = Exposed pad.

ABSOLUTE MAXIMUM RATINGS

VDD to VSS	Maximum Junction Temperature+150°C Storage Temperature Range65°C to +150°C
Multilayer Board2285.7mW	

Note 1: Maximum power dissipation is obtained using JEDEC JESD51-5 and JESD51-7 specifications.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS (Note 2)

TOFN

Junction-to-Ambient Thermal Resistance (θJA)......35°C/W Junction-to-Case Thermal Resistance (θJC)......2.7°C/W

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to http://www.maxim-ic.com/thermal-tutorial.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = (V_{DD} - V_{SS}) = 48V, R_{DET} = 24.9k\Omega, R_{CLS} = 615\Omega, and R_{\overline{SL}} = 60.4k\Omega. RTN, WAD, PG, and <math>\overline{2EC}$ unconnected, all voltages are referenced to V_{SS} , unless otherwise noted. $T_A = T_J = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 3)

PARAMETER	SYMBOL	CC	ONDITIONS	MIN	TYP	MAX	UNITS	
DETECTION MODE								
Input Offset Current	IOFFSET	$V_{IN} = 1.4V \text{ to } 10.$	1V (Note 4)			10	μΑ	
Effective Differential Input Resistance	dR	· ·	$V_{IN} = 1.4V$ up to 10.1V with 1V step, $V_{DD} = RTN = WAD = PG = \overline{2EC}$ (Note 5)			25.50	kΩ	
CLASSIFICATION MODE								
Classification Disable Threshold	VTH,CLS	V _{IN} rising (Note 6	5)	22.0	22.8	23.6	V	
Classification Stability Time					0.2		ms	
	1	$V_{IN} = 12.5V \text{ to}$ $20.5V, V_{DD} =$ $RTN = WAD =$ $PG = \overline{2EC}$	Class 0, R _{CLS} = 619Ω	0		3.96	- mA	
			Class 1, R _{CLS} = 117Ω	9.12		11.88		
Classification Current			Class 2, R _{CLS} = 66.5Ω	17.2		19.8		
Classification Current	ICLASS		Class 3, RCLS = 43.7Ω	26.3		29.7		
			Class 4, R _{CLS} = 30.9Ω	36.4		43.6		
			Class 5, RCLS = 21.3Ω	52.7		63.3		
TYPE 2 (802.3at) CLASSIFICA	TION MODE							
Mark Event Threshold	VTHM	V _{IN} falling		10.1	10.7	11.6	V	
Hysteresis on Mark Event Threshold					0.84		V	

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = (V_{DD} - V_{SS}) = 48V, R_{DET} = 24.9k\Omega, R_{CLS} = 615\Omega, and R_{\overline{SL}} = 60.4k\Omega. RTN, WAD, PG, and <math>\overline{2EC}$ unconnected, all voltages are referenced to V_{SS} , unless otherwise noted. $T_A = T_J = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 3)

PARAMETER	SYMBOL	cc	ONDITIONS	MIN	TYP	MAX	UNITS
Mark Event Current	IMARK	V _{IN} falling to enter mark event, 5.2V ≤ V _{IN} ≤ 10.1V		0.25		0.85	mA
Reset Event Threshold	VTHR	V _{IN} falling		2.8	4	5.2	V
POWER MODE							•
V _{IN} Supply Voltage Range						60	V
VIN Supply Current	IQ				0.27	0.55	mA
V _{IN} Turn-On Voltage	Von	V _{IN} rising		34.3	35.4	36.6	V
VIN Turn-Off Voltage	Voff	V _{IN} falling		30			V
V _{IN} Turn-On/-Off Hysteresis	VHYST_ UVLO	(Note 7)		4.2			V
V _{IN} Deglitch Time	toff_dly	V _{IN} falling from 4	0V to 20V (Note 8)	30	120		μs
Inrush to Operating Mode Delay	tDELAY	tDELAY = minimum after entering into	m PG current pulse width power mode	87	96	105	ms
			T _J = +25°C		0.5	0.7	
Isolation Power MOSFET On-Resistance	Ron_iso	I _{RTN} = 600mA	T _J = +85°C		0.65	1	Ω
Jii-nesistarice		T _J = +125°C		0.8		1	
RTN Leakage Current	IRTN_LKG	V _{RTN} = 12.5V to 3	V _{RTN} = 12.5V to 30V			10	μΑ
CURRENT LIMIT							•
Inrush Current Limit	INRUSH	During initial turn- V _{RTN} = 1.5V	-on period,	90	135	180	mA
Current Limit During Normal Operation	ILIM	After inrush completed, VRTN = 1V		720	800	880	mA
Foldback Threshold		VRTN (Note 9)		13		16.5	V
LOGIC							
WAD Detection Threshold	Vwad-ref	V _{WAD} rising, V _{IN} = 14V to 48V (referenced to RTN)		8	9	10	V
WAD Detection Threshold		VWAD falling, VRTN = 0V, VSS			0.705		.,
Hysteresis		unconnected			0.725		V
WAD Input Current	lwad-lkg	V _{WAD} = 10V (refe	erenced to RTN)			3.5	μΑ
2EC Sink Current		VZEC = 3.5V (referenced to RTN), VSS unconnected		1	1.5	2.25	mA
2EC Off-Leakage Current		V _{2EC} = 48V				1	μΑ

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = (V_{DD} - V_{SS}) = 48V, R_{DET} = 24.9k\Omega, R_{CLS} = 615\Omega, and R_{\overline{SL}} = 60.4k\Omega. RTN, WAD, PG, and <math>\overline{2EC}$ unconnected, all voltages are referenced to V_{SS}, unless otherwise noted. T_A = T_J = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
PG Sink Current		V _{RTN} = 1.5V, V _{PG} = 0.8V, during inrush period	125	230	375	μA
PG Off-Leakage Current		VPG = 60V			1	μΑ
THERMAL SHUTDOWN						
Thermal-Shutdown Threshold	T _{SD}	T _J rising		+140		°C
Thermal-Shutdown Hysteresis		T _J falling		28		°C

- Note 3: This device is 100% production tested at T_A = +25°C. Limits over temperature are guaranteed by design.
- Note 4: The input offset current is illustrated in Figure 1.
- Note 5: Effective differential input resistance is defined as the differential resistance between VDD and VSS. See Figure 1.
- Note 6: Classification current is turned off whenever the device is in power mode.
- Note 7: UVLO hysteresis is guaranteed by design, not production tested.
- Note 8: A 20V glitch on input voltage, which takes VDD below VON shorter than or equal to tOFF_DLY does not cause the MAX5969D to exit power-on mode.
- **Note 9:** In power mode, current-limit foldback is used to reduce the power dissipation in the isolation MOSFET during an overload condition across V_{DD} and RTN.

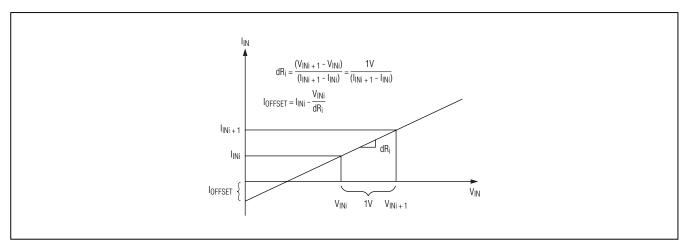
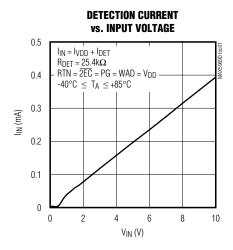
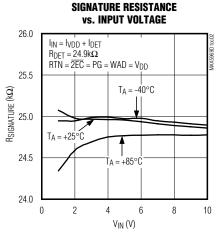


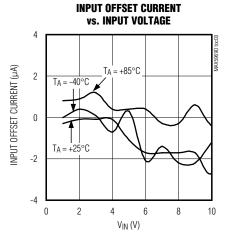
Figure 1. Effective Differential Input Resistance/Offset Current

Typical Operating Characteristics

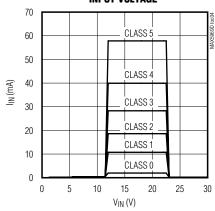
 $(V_{IN} = (V_{DD} - V_{SS}) = 54V, R_{DET} = 24.9k\Omega, R_{CLS} = 615\Omega, and R_{\overline{SL}} = 60.4k\Omega. RTN, WAD, PG, and <math>\overline{2EC}$ unconnected; all voltages are referenced to V_{SS} .)



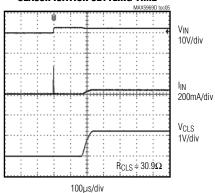




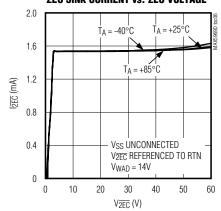
CLASSIFICATION CURRENT vs. INPUT VOLTAGE



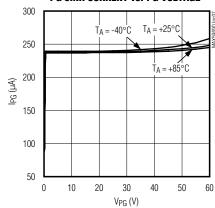




<u>2EC</u> SINK CURRENT vs. <u>**2EC**</u> VOLTAGE

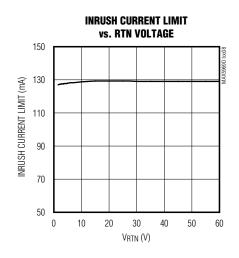


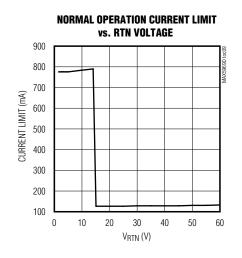
PG SINK CURRENT vs. PG VOLTAGE



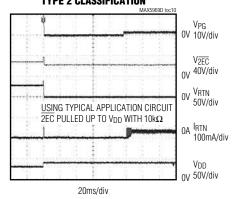
Typical Operating Characteristics (continued)

 $(V_{IN} = (V_{DD} - V_{SS}) = 54V, R_{DET} = 24.9k\Omega, R_{CLS} = 615\Omega, and R_{\overline{SL}} = 60.4k\Omega. RTN, WAD, PG, and <math>\overline{2EC}$ unconnected; all voltages are referenced to Vss.)

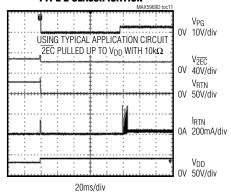




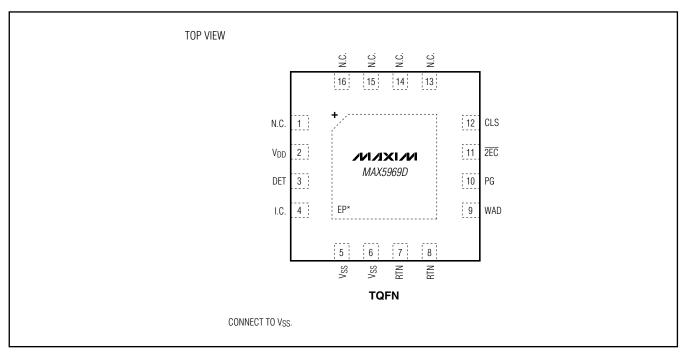
INRUSH CONTROL WAVEFORM WITH TYPE 2 CLASSIFICATION



INRUSH CONTROL WAVEFORM WITH TYPE 2 CLASSIFICATION



Pin Configuration



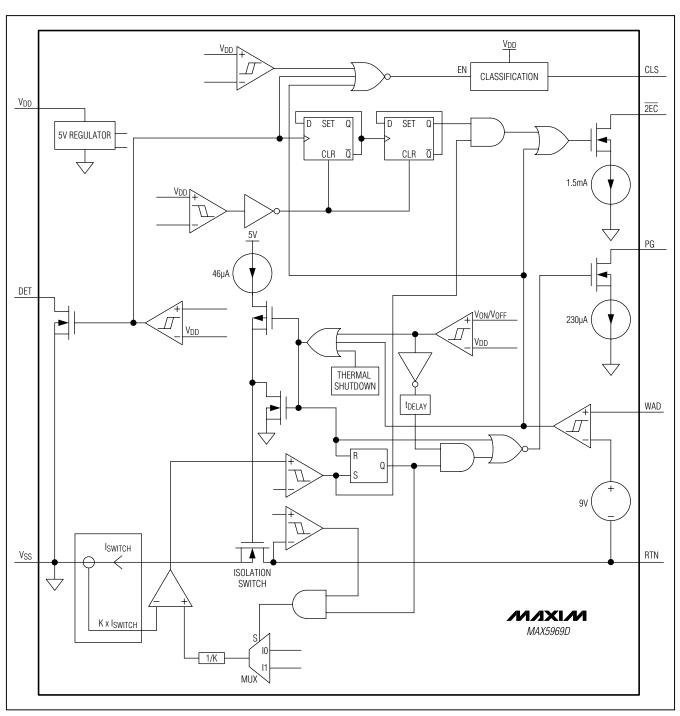
Pin Description

PIN	NAME	FUNCTION
1, 13–16	N.C.	No Connection. Not internally connected. Leave N.C. unconnected.
2	V_{DD}	Positive Supply Input. Connect a 68nF (min) bypass capacitor between VDD and VSS.
3	DET	Detection Resistor Input. Connect a signature resistor (RDET = 24.9kΩ) from DET to VDD.
4	I.C.	Internally Connected. Leave unconnected, leave I.C. unconnected.
5, 6	Vss	Negative Supply Input. VSS connects to the source of the integrated isolation n-channel power MOSFET.
Drain of Isolation MOSFET. RTN connects to the drain of the integrated isolation n-chan		Drain of Isolation MOSFET. RTN connects to the drain of the integrated isolation n-channel power MOSFET. Connect RTN to the downstream DC-DC converter ground as shown in the <i>Typical Application Circuit</i> .

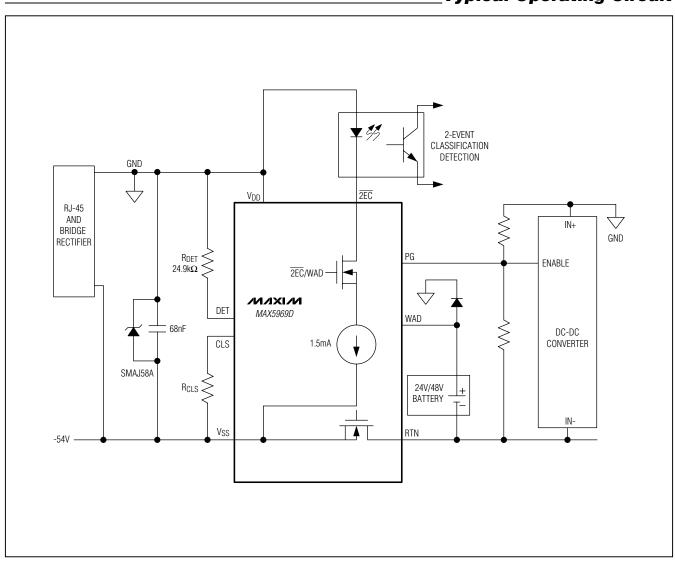
Pin Description (continued)

PIN	NAME	FUNCTION
9	WAD	Wall Power Adapter Detector Input. Wall adapter detection is enabled the moment V _{DD} - V _{SS} crosses the mark event threshold. Detection occurs when the voltage from WAD to RTN is greater than 9V. When a wall power adapter is present, the isolation n-channel power MOSFET turns off, 2EC current sink turns on. Connect WAD directly to RTN when the wall power adapter or other auxiliary power source is not used.
10	PG	Open-Drain Power-Good Indicator Output. PG sinks 230µA to disable the downstream DC-DC converter while turning on the hot-swap MOSFET switch. PG current sink is disabled during detection, classification, and in the steady-state power mode. The PG current sink is turned on to disable the downstream DC-DC converter when the device is in sleep mode.
11	2EC	2-Event Classification Detect or Wall Adapter Detect Output. A 1.5mA current sink is enabled at \$\overline{2EC}\$ when a Type 2 PSE or a wall adapter is detected. When powered by a Type 2 PSE, the \$\overline{2EC}\$ current sink is enabled after the isolation MOSFET is fully on until VIN drops below the UVLO threshold. \$\overline{2EC}\$ is latched when powered by a Type 2 PSE until VIN drops below the reset threshold. \$\overline{2EC}\$ also asserts when a wall adapter supply, typically greater than 9V, is applied between WAD and RTN. \$\overline{2EC}\$ is not latched if asserted by WAD. The \$\overline{2EC}\$ current sink is turned off when the device is in sleep mode.
12	CLS	Classification Resistor Input. Connect a resistor (R _{CLS}) from CLS to V _{SS} to set the desired classification current. See the classification current specifications in the <i>Electrical Characteristics</i> table to find the resistor value for a particular PD classification.
_	EP	Exposed Pad. Do not use EP as an electrical connection to Vss. EP is internally connected to Vss through a resistive path and must be connected to Vss externally. To optimize power dissipation, solder the exposed pad to a large copper power plane.

Simplified Block Diagram



Typical Operating Circuit



Detailed Description

Operating Modes

Depending on the input voltage (VIN = VDD - VSS), the MAX5969D operates in four different modes: PD detection, PD classification, mark event, and PD power. The device enters PD detection mode when the input voltage is between 1.4V and 10.1V. The device enters PD classification mode when the input voltage is between 12.6V and 20V. The device enters PD power mode once the input voltage exceeds VON.

Detection Mode $(1.4V \le V_{IN} \le 10.1V)$

In detection mode, the power source equipment (PSE) applies two voltages on V_{IN} in the 1.4V to 10.1V range (1V step minimum) and then records the current measurements at the two points. The PSE then computes $\Delta V/\Delta I$ to ensure the presence of the 24.9k Ω signature resistor. Connect the signature resistor (RDET) from VDD to DET for proper signature detection. The MAX5969D pulls DET low in detection mode. DET goes high impedance when the input voltage exceeds 12.5V. In detection mode, most of the MAX5969D internal circuitry is off and the offset current is less than $10\mu A$.

If the voltage applied to the PD is reversed, install protection diodes at the input terminal to prevent internal damage to the MAX5969D (see the *Typical Application Circuit*). Since the PSE uses a slope technique ($\Delta V/\Delta I$) to calculate the signature resistance, the DC offset due to the protection diodes is subtracted and does not affect the detection process.

Classification Mode (12.6 $V \le V_{IN} \le 20V$)

In the classification mode, the PSE classifies the PD based on the power consumption required by the PD. This allows

the PSE to efficiently manage power distribution. Class 0–5 is defined as shown in Table 1. (The IEEE 802.3af/at standard defines only Class 0–4 and Class 5 for any special requirement.) An external resistor (R_{CLS}) connected from CLS to V_{SS} sets the classification current.

The PSE determines the class of a PD by applying a voltage at the PD input and measuring the current sourced out of the PSE. When the PSE applies a voltage between 12.6V and 20V, the MAX5969D exhibits a current characteristic with a value shown in Table 1. The PSE uses the classification current information to classify the power requirement of the PD. The classification current includes the current drawn by RCLS and the supply current of the MAX5969D so the total current drawn by the PD is within the IEEE 802.3af/at standard figures. The classification current is turned off whenever the device is in power mode.

2-Event Classification and Detection

During 2-event classification, a Type 2 PSE probes PD for classification twice. In the first classification event, the PSE presents an input voltage between 12.6V and 20.5V and the MAX5969D presents the programmed load ICLASS. The PSE then drops the probing voltage below the mark event threshold of 10.1V and the MAX5969D presents the mark current (IMARK). This sequence is repeated one more time.

When the MAX5969D is powered by a Type 2 PSE, the 2-event identification output $\overline{2EC}$ asserts low after the internal isolation n-channel MOSFET is fully turned on. $\overline{2EC}$ current sink is turned off when VDD goes below the UVLO threshold (VOFF) and turns on when VDD goes above the UVLO threshold (VON), unless VDD goes below VTHR to reset the latched output of the Type 2 PSE detection flag.

Table 1. Setting Classification Current

CLASS	MAXIMUM POWER USED BY PD	RcLs (Ω)	V _{IN} * (V)		CLASS CURRENT SEEN AT VIN (mA)		2.3at PD ION CURRENT ITION (mA)
	(W)			MIN	MAX	MIN	MAX
0	0.44 to 12.95	615	12.6 to 20	0	4	0	5
1	0.44 to 3.94	117	12.6 to 20	9	12	8	13
2	3.84 to 6.49	66.5	12.6 to 20	17	20	16	21
3	6.49 to 12.95	43.7	12.6 to 20	26	30	25	31
4	12.95 to 25.5	30.9	12.6 to 20	36	44	35	45
5	> 25.5	21.3	12.6 to 20	54	64	51	68

^{*}VIN is measured across the MAX5969D input VDD to VSS.

Alternatively, the $\overline{\text{2EC}}$ output also serves as a wall adapter detection output when the MAX5969D is powered by an external wall power adapter. See the *Wall Power Adapter Detection and Operation* section for more information.

Power Mode

The MAX5969D enters power mode when V_{IN} rises above the undervoltage lockout threshold (V_{ON}). When V_{IN} rises above V_{ON}, the MAX5969D turns on the internal n-channel isolation MOSFET to connect V_{SS} to RTN with inrush current limit internally set to 135mA (typ). The isolation MOSFET is fully turned on when the voltage at RTN is near V_{SS} and the inrush current is reduced below the inrush limit. Once the isolation MOSFET is fully turned on, the MAX5969D changes the current limit to 800mA. The open-drain power-good output (PG) remains low for a minimum of t_{DELAY} until the power MOSFET fully turns on to keep the downstream DC-DC converter disabled during inrush.

Undervoltage Lockout

The MAX5969D operates up to a 60V supply voltage with a turn-on UVLO threshold (VON) at 35.4V and a turn-off UVLO threshold (VOFF) at 31V. When the input voltage is above VON, the MAX5969D enters power mode and the internal MOSFET is turned on. When the input voltage goes below VOFF for more than tOFF_DLY, the MOSFET turns off.

Power-Good Output

An open-drain output (PG) is used to allow disabling downstream DC-DC converter until the n-channel isolation MOSFET is fully turned on. PG is pulled low to VSS for a period of tDELAY and until the internal isolation MOSFET is fully turned on. The PG is also pulled low during sleep mode and coming out of thermal shutdown.

Thermal-Shutdown Protection

The MAX5969D includes thermal protection from excessive heating. If the junction temperature exceeds the thermal-shutdown threshold of +140°C, the MAX5969D turns off the internal power MOSFET, LED driver, and $\overline{\rm 2EC}$ current sink. When the junction temperature falls below +112°C, the devices enter inrush mode and then return

to power mode. Inrush mode ensures the downstream DC-DC converter is turned off as the internal power MOSFET is turned on.

Wall Power Adapter Detection and Operation

For applications where an auxiliary power source such as a wall power adapter is used to power the PD, the MAX5969D features wall power adapter detection. The MAX5969D gives highest priority to the WAD and smoothly switch the power supply to WAD when it is detected. Once the input voltage (VDD - VSS) exceeds the mark event threshold, the MAX5969D enables wall adapter detection. The wall power adapter is connected from WAD to RTN. The MAX5969D detects the wall power adapter when the voltage from WAD to RTN is greater than 9V. When a wall power adapter is detected, the internal n-channel isolation MOSFET turns off, $\overline{\rm 2EC}$ current sink turns on, and classification current is disabled if VIN is in the classification range.

Applications Information

Operation with 12V Adapter

Layout Procedure

Careful PCB layout is critical to achieve high efficiency and low EMI. Follow these layout guidelines for optimum performance:

- Place the input capacitor, classification resistor, and transient voltage suppressor as close as possible to the MAX5969D.
- Use large SMT component pads for power dissipating devices such as the MAX5969D and the external diodes.
- 3) Use short and wide traces for high-power paths.
- 4) Use the MAX5969 evaluation kit layout as a reference.
- 5) Place enough vias in the pad for the EP of the MAX5969D so that heat generated inside can be effectively dissipated by the PCB copper. The recommended spacing for the vias is 1mm to 1.2mm pitch. The thermal vias should be plated (1oz copper) and have a small barrel diameter (0.3mm to 0.33mm).

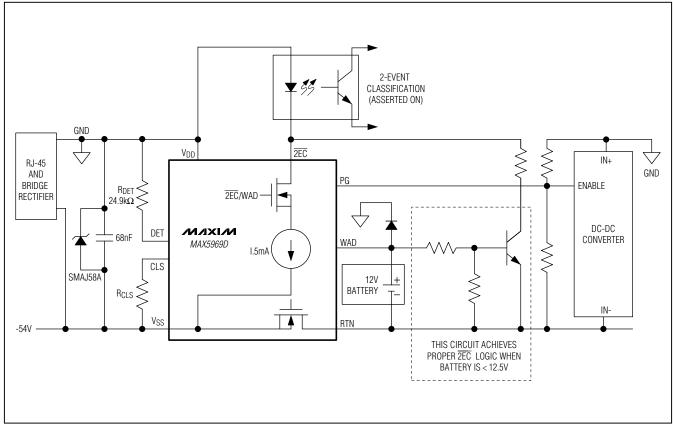
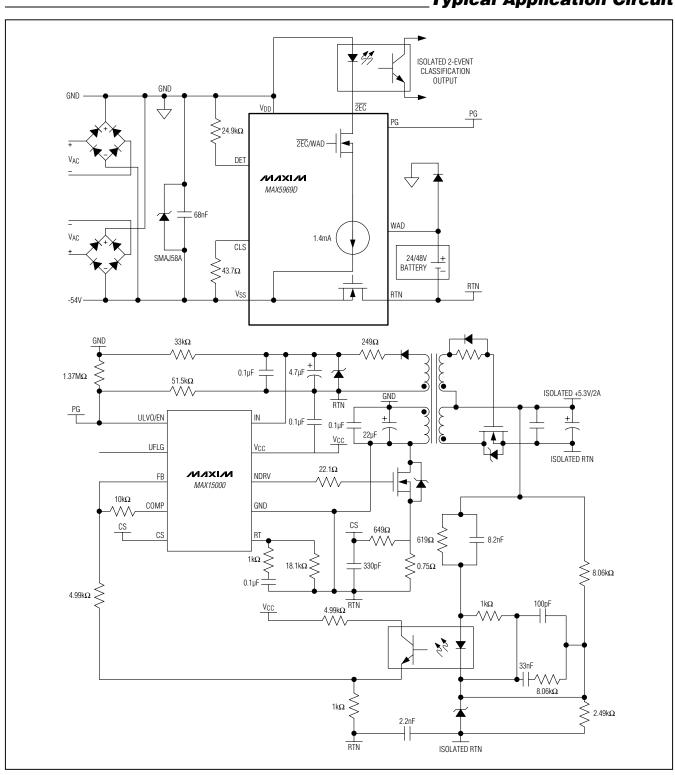


Figure 2. Typical Configuration When Using a 12V Wall Power Adapter

Typical Application Circuit



Chip Information

PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns (footprints), go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
16 TQFN-EP	T1655+4	21-0140	

MIXIM

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	6/11	Initial release	_

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.